

N- and P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY						
	V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A)			
		$0.060 \text{ at V}_{GS} = 4.5 \text{ V}$	3.4			
N-Channel	20	0.070 at V _{GS} = 2.5 V	3.2			
		0.100 at V _{GS} = 1.8 V	2.5			
		0.110 at V _{GS} = - 4.5 V	- 2.5			
P-Channel	- 20	0.145 at V _{GS} = - 2.5 V	- 2.0			
		0.220 at V _{GS} = - 1.8V	- 1.0			

FEATURES

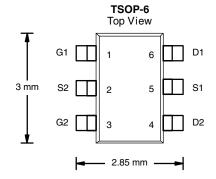
- TrenchFET® Power MOSFET
- Fast Switching In Small Footprint
- Very Low r_{DS(on)} for Increased Efficiency



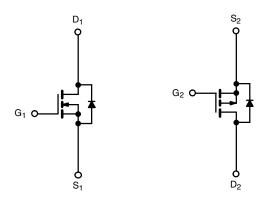
RoHS COMPLIANT

APPLICATIONS

· Load Switch for Portable Devices



Ordering Information: Si3586DV-T1-E3 (Lead (Pb)-free)



N-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted								
Parameter		Symbol	N-Channel		P-Channel		Unit	
			5 sec	Steady State	5 sec	Steady State	Unit	
Drain-Source Voltage		V_{DS}	20		- 20		V	
Gate-Source Voltage		V_{GS}	± 8				- V	
O-11-0-0-1/T 450.00/8	T _A = 25 °C	- I _D	3.4	2.9	- 2.5	- 2.1		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		2.7	2.3	- 2.0	- 1.7		
Pulsed Drain Current		I _{DM}	± 8				Α	
Continuous Source Current (Diode Conduction) ^a		I _S	1.05	0.75	- 1.05	- 0.75		
	T _A = 25 °C	P _D	1.15	0.83	1.15	0.83	W	
Maximum Power Dissipation ^a	T _A = 70 °C	' D	0.73	0.53	0.73	0.53		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150				°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^a	t ≤ 5 sec	R _{thJA}	93	110	°C/W		
	Steady State		130	150			
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	90	90			

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

New Product



SPECIFICATIONS $T_J = 25$ °C, unless otherwise noted									
Parameter	Symbol	Test Conditions	Test Conditions			Max	Unit		
Static	•					•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$ N-Ch $V_{DS} = V_{GS}, I_D = -250 \mu A$ P-Ch		0.40		1.1	V		
				- 0.40		- 1.1			
Gate-Body Leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	N-Ch			± 100	nA		
	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	P-Ch			± 100			
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V	N-Ch			1			
		V _{DS} = - 20 V, V _{GS} = 0 V P-Ch				- 1	μΑ		
		V _{DS} = 20 V, V _{GS} = 0 V, T _J = 85 °C N-				10			
		V _{DS} = - 20 V, V _{GS} = 0 V, T _J = 85 °C	P-Ch			- 10			
	,	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	N-Ch	I-Ch 5					
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	P-Ch	- 5			Α		
		$V_{GS} = 4.5 \text{ V}, I_D = 3.4 \text{ A}$	N-Ch		0.047	0.060			
		V _{GS} = - 4.5 V, I _D = - 2.5 A	P-Ch		0.086	0.110	Ω		
	_	V _{GS} = 2.5 V, I _D = 3.2 A	N-Ch		0.054	0.070			
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 2.0 A	P-Ch		0.116	0.145			
		V _{GS} = - 1.8 V, I _D = - 2.5 A	N-Ch		0.075	0.100			
		V _{GS} = - 1.8 V, I _D = - 1.0 A	P-Ch		0.170	0.220			
	9 _{fs}	$V_{DS} = 5 \text{ V}, I_{D} = 3.4 \text{ A}$	N-Ch		13				
Forward Transconductance ^a		V _{DS} = - 5 V, I _D = - 2.5 A	P-Ch		6		S		
	V _{SD}	I _S = 1.05 A, V _{GS} = 0 V	N-Ch		0.8	1.1	.,		
Diode Forward Voltage ^a		I _S = - 1.05 A, V _{GS} = 0 V	V P-Ch		- 0.8	- 1.1	V		
Dynamic ^b									
Total Gate Charge	Q _g	N-Channel	N-Ch		4.1	6.0			
		$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 3.4 \text{ A}$	P-Ch		5	7.5	nC		
Gate-Source Charge			N-Ch P-Ch		0.65				
		P-Channel	N-Ch		0.68				
Gate-Drain Charge	Q_{gd}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -2.5 \text{ A}$	P-Ch		1.3				
	R _g		N-Ch		2.6				
Gate Resistance			P-Ch		9.8		Ω		
Turn-On Delay Time	t _{d(on)}		N-Ch		30	45			
		N-Channel $V_{DD} = 10 \text{ V, R}_{L} = 10 \Omega$	P-Ch		28	45	ns		
Rise Time Turn-Off Delay Time	t _r	$I_D \cong 1 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_G = 6 \Omega$	N-Ch		52	85			
		- Julia - Juli	P-Ch		55	85			
		P-Channel	N-Ch P-Ch		25 55	40 85			
Fall Time	t _f	$V_{DD} = -10 \text{ V}, R_L = 10 \Omega$ $I_D \cong -1 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_G = 6 \Omega$	N-Ch		20	30			
		1D = - 1 A, VGEN = - 4.5 V, FIG = 6 12	P-Ch		32	50			
		I _F = 1.05 A, di/dt = 100 A/μs	N-Ch		25	40	1		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 1.05 A, di/dt = 100 A/μs			25	40			

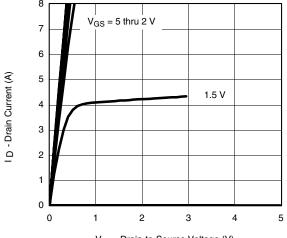
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

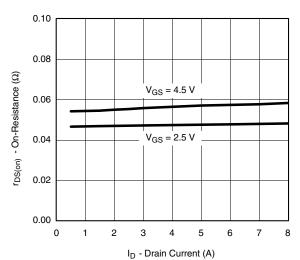
b. Guaranteed by design, not subject to production testing.



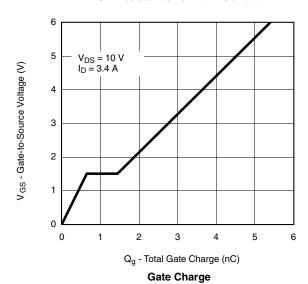
N-CHANNEL TYPICAL CHARACTERISTICS 25 °C unless noted



V_{DS} - Drain-to-Source Voltage (V) **Output Characteristics**



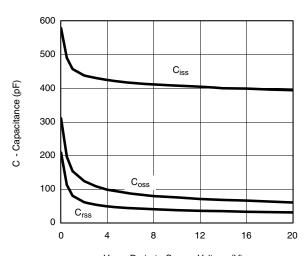
On-Resistance vs. Drain Current



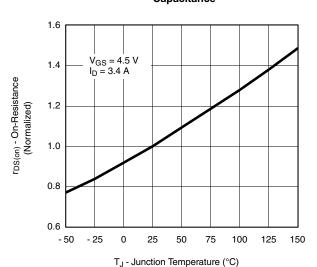
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V_{GS} - Gate-to-Source Voltage (V)

Transfer Characteristics



V_{DS} - Drain-to-Source Voltage (V) **Capacitance**

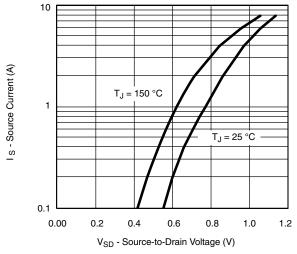


On-Resistance vs. Junction Temperature

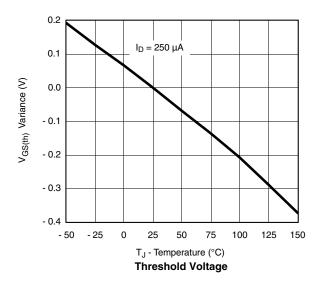
New Product

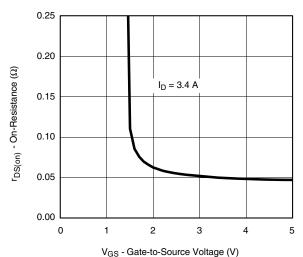


N-CHANNEL TYPICAL CHARACTERISTICS 25 °C unless noted

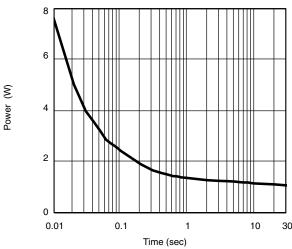


Source-Drain Diode Forward Voltage

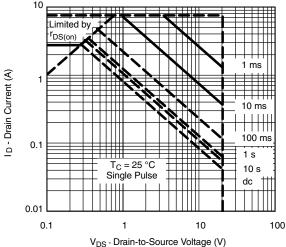




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power (Junction-to-Ambient)

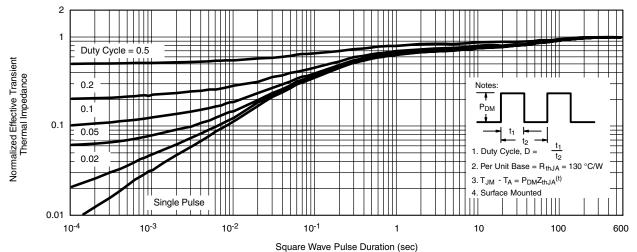


* V_{GS} > minimum V_{GS} at which r_{DS(on)} is specified

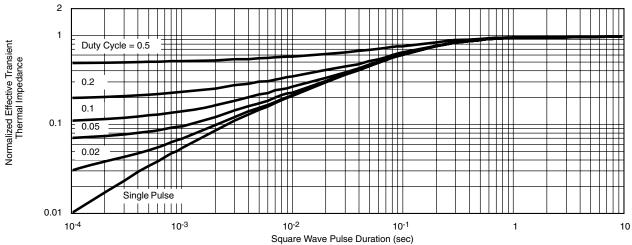
Safe Operating Area, Junction-to-Case



N-CHANNEL TYPICAL CHARACTERISTICS 25 °C unless noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

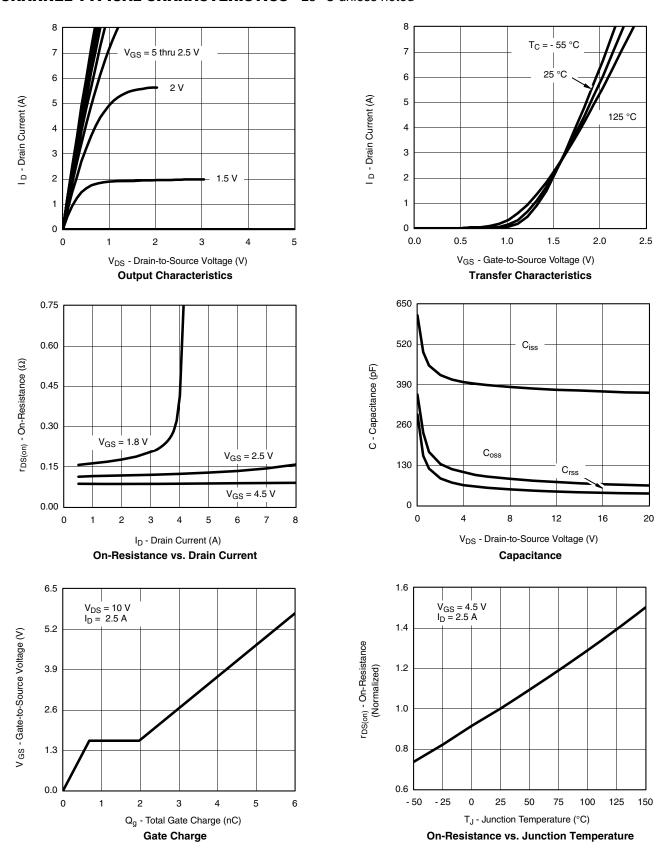


Normalized Thermal Transient Impedance, Junction-to-Foot

New Product

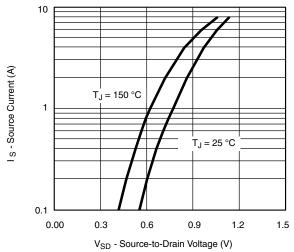


P-CHANNEL TYPICAL CHARACTERISTICS 25 °C unless noted

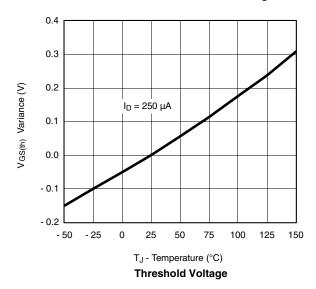


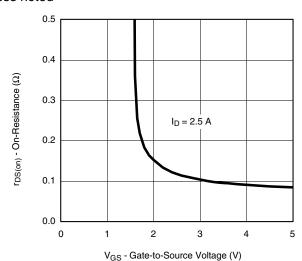


P-CHANNEL TYPICAL CHARACTERISTICS 25 °C unless noted

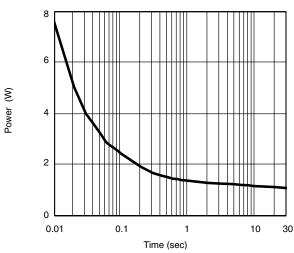


Source-Drain Diode Forward Voltage

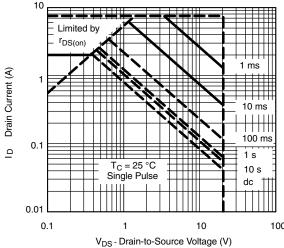




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power (Junction-to-Ambient)



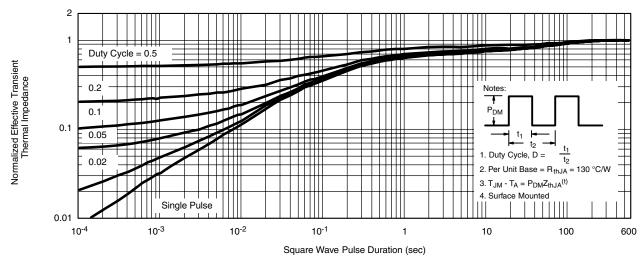
* V_{GS} > minimum V_{GS} at which r_{DS(on)} is specified

Safe Operating Area, Junction-to-Case

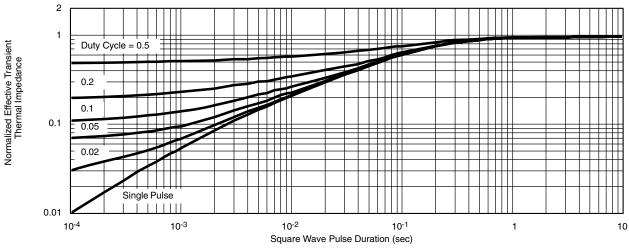
New Product



P-CHANNEL TYPICAL CHARACTERISTICS 25 °C unless noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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